

TIDA-00675 REV E1 Bill of Materials



Item #	Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
1	IPC8	1		TIDA-00675	Any	Printed Circuit Board	
2	C1, C3	2	3.3uF	GRM188R61A33RKE15D	MuRata	CAP, CERM, 3.3 uF, 10 V, +/- 10%, XSR, 0603	0603
3	C1_1, C1_2	2	10uF	GRM21BR71A106KE51L	MuRata	CAP, CERM, 10 uF, 10 V, +/- 10%, XTR, 0805	0805
4	C2, C4	2	0.01uF	GRM188R71H103KA01D	MuRata	CAP, CERM, 0.01 uF, 50 V, +/- 10%, XTR, 0603	0603
5	C2_1, C2_2, C02, C03	4	22uF	GRM31CR71A226KE15L	MuRata	CAP, CERM, 22 uF, 10 V, +/- 10%, XTR, 1206	1206
6	C3_1, C3_2, C4_1, C4_2	4	0.01uF	GRM155R71H103KA88D	MuRata	CAP, CERM, 0.01 uF, 50 V, +/- 10%, XTR, 0402	0402
7	C5_1, C5_2, C6_1, C6_2	4	470pF	GRM155R71H471KA01D	MuRata	CAP, CERM, 470 pF, 50 V, +/- 10%, XTR, 0402	0402
8	CB1, CB2, CB3, CS4, CN1, CN2, CN3, CN4	8	1uF	C1608X7R1E105K080AB	TDK	CAP, CERM, 1 uF, 25 V, +/- 10%, XTR, 0603	0603
9	CCOMP	1	8200pF	GRM188R72A822KA01D	MuRata	CAP, CERM, 8200 pF, 100 V, +/- 10%, XTR, 0603	0603
10	CCS	1	0.1uF	C1608X7R1H104K	TDK	CAP, CERM, 0.1 uF, 50 V, +/- 10%, XTR, 0603	0603
11	CFT	1	75pF	GRM188R5C1H750LA01D	MuRata	CAP, CERM, 75 pF, 50 V, +/- 5%, COG/NPO, 0603	0603
12	CHB	1	0.47uF	GRM21BR72A474K73L	MuRata	CAP, CERM, 0.47 uF, 100 V, +/- 10%, XTR, 0805	0805
13	CHF	1	8pF	GQM2195C2A8R0C801D	MuRata	CAP, CERM, 8 pF, 100 V, +/- 5%, COG/NPO, 0805	0805
14	CIN1_3	1	68uF	S05VFP68M	Panasonic	CAP, Aluminum Polymer, 68 uF, 50 V, +/- 20%, 0.02 ohm, F12, SMD, 2 Leads, Body 10.5x10.5mm, Height 12.7mm SMD	F12, SMD, 2-Leads, Height 12.7mm
15	CIN2_3, CIN3_2	2	10uF	GRM32ER81H106KA12L	MuRata	CAP, CERM, 10 uF, 50 V, +/- 10%, XSR, 1210	1210
16	CIN5, CL1, CL2, CL3, CL4, CL6	6	0.1uF	C1608X8R1E104K	TDK	CAP, CERM, 0.1 uF, 25 V, +/- 10%, XBR, 0603	0603
17	CIN6	1	22uF	EAW/H101ADA220MAJ0G	Chemi-Con	CAP, AL, 22 uF, 100 V, +/- 20%, 0.55 ohm, SMD	J40
18	C15	1	4.7uF	E2012X7R1A475M	TDK	CAP, CERM, 4.7 uF, 10 V, +/- 20%, XTR, 0805	0805
19	CO1	1	470uF	APXE100ARA471M80G	Chemi-Con	CAP, AL, 470 uF, 10 V, +/- 20%, 0.019 ohm, SMD	J80
20	CRAMP	1	820pF	GRM188R72A821KA01D	MuRata	CAP, CERM, 820 pF, 100 V, +/- 10%, XTR, 0603	0603
21	CRFS, CSS	2	0.58uF	GRM31MR71H884KA88L	MuRata	CAP, CERM, 0.58 uF, 50 V, +/- 10%, XTR, 1206	1206
22	CV02	1	1uF	GRM21BR71H105KA12L	MuRata	CAP, CERM, 1 uF, 50 V, +/- 10%, XTR, 0805	0805
23	D1, D2	2	15V	LSM115E3/TR13	Microsemi	Diode, Schottky, 15 V, 1 A, DO-214BA	DO-214BA
24	D3, D4, D5, D6, D7, D8	6	Green	LTST-C170KGT	Lite-On	LED, Green, SMD	LED_0605
25	DHB	1	20V	RSX501L-20TE25	Rohm	Diode, Schottky, 20 V, 5 A, SMA	SMA
26	FID4, FID5, FID6	3	N/A	N/A	N/A	Fiducial mark. There is nothing to buy or mount.	Fiducial
27	H1, H2, H3, H4	4		SJ-5303 (CLEAR)	3M	Bump-on, Hemisphere, 0.44 X 0.20, Clear	Transparent Bump-on
28	J1	1		SPT15363	Terma	BANANA JACK, SOLDER LUG, RED, TH	Red Insulated Banana Jack
29	J2	1		SPT15354	Terma	BANANA JACK, SOLDER LUG, BLACK, TH	Black Insulated Banana Jack
30	J3, J4, J5, J6	4		39357-0002	Molex	Terminal Block, 3.5 mm, 2x1, Tin, TH	Terminal Block, 3.5 mm, 2x1, TH
31	J7, J8, J9, J10, J19, J21, TP1, TPC1, TPC2, TPC3, TPC4, TPC5, TPC6	12		61300211121	Würth Elektronik	Header, 2.54 mm, 2x1, Gold, TH	Header, 2.54mm, 2x1, TH
32	J11, J12, J13, J14, J15, J16, J17, J18, J20, J22	10		61300311121	Würth Elektronik	Header, 2.54 mm, 3x1, Gold, TH	Header, 2.54mm, 3x1, TH
33	L1_1, L1_2	2	1uH	NAL4020-102MEB	Coilcraft	Inductor, Shielded Composite, 1 uH, 8.75 A, 0.01 ohm, SMD	4x2.5x4mm
34	L3	1	10uH	PM2110-100K-RC	Bourns	Inductor, Toroid, 10 uH, 11.7 A, 0.007 ohm, SMD	30.5x15.75x25.4mm
35	QH, QL	2	60V	CSD18563Q5A	Texas Instruments	MOSFET, N-CH, 60 V, 15 A, SON 5x6mm	SON 5x6mm
36	R1, R2, R3, R4, R5, R6	6	150	CRCW0603150R1NEA	Vishay-Dale	RES, 150, 5%, 0.1 W, 0603	0603
37	R1_1	1	499k	CRCW0603499KFKEA	Vishay-Dale	RES, 499 k, 1%, 0.1 W, 0603	0603
38	R1_2	1	200k	RC0603FR-07200K	Yageo America	RES, 200 k, 1%, 0.1 W, 0603	0603
39	R2_1, R2_2	2	160k	CRCW0603160KFKEA	Vishay-Dale	RES, 160 k, 1%, 0.1 W, 0603	0603
40	R4_1, R4_2	2	200k	CRCW0603200K1NEA	Vishay-Dale	RES, 200 k, 5%, 0.1 W, 0603	0603
41	RB1, RB2, RT1, RT2	4	110	CRCW0603110R1NEA	Vishay-Dale	RES, 110, 5%, 0.1 W, 0603	0603
42	RBA1, RBA2, RTA1, RTA2	4	50k	3352T-1-503LF	Bourns	Tapping Potentiometer, 50k, 0.5W, TH	9.53x8.89mm
43	RC1, RC2, RC3, RC4, RC5, RC6	6	0.005	PMR25H2PFSU5L00	Rohm	RES, 0.005, 1%, 1 W, 1210	1210
44	RCOMP	1	60.4k	RC0603FR-0760K4L	Yageo America	RES, 60.4 k, 1%, 0.1 W, 0603	0603
45	RCS1, RCS2	2	10	CRCW060310R01NEA	Vishay-Dale	RES, 10, 5%, 0.1 W, 0603	0603
46	RD1, RD2, RD3, RD4, RD5, RD6	6	0	CRCW06030000Z0EA	Vishay-Dale	RES, 0, 5%, 0.1 W, 0603	0603
47	RF1_3	1	1.00k	RC0603FR-0710K	Yageo America	RES, 1.00 k, 1%, 0.1 W, 0603	0603
48	RFB2_3	1	5.23k	RC0603FR-075K23L	Yageo America	RES, 5.23 k, 1%, 0.1 W, 0603	0603
49	RGH, RGL	2	0	CRCW06030000Z0EA	Vishay-Dale	RES, 0, 5%, 0.125 W, 0805	0805
50	RPU1, RPU2	2	10k	RC0603JR-0710K	Yageo America	RES, 10 k, 5%, 0.1 W, 0603	0603
51	RRAIMP	1	102k	RC0603FR-07102K	Yageo America	RES, 102 k, 1%, 0.1 W, 0603	0603
52	RS1, RS2, RS3	3	0.004	KRL8432E-M-R004-F-T1	Samsung Co Ltd	RES, 0.004, 1%, 3 W, 2512 WIDE	2512 WIDE
53	RT_3	1	16.5k	CRCW0603165KFKEA	Vishay-Dale	RES, 16.5 k, 1%, 0.1 W, 0603	0603
54	RLV1	1	14.0k	RC0603FR-0714K	Yageo America	RES, 14.0 k, 1%, 0.1 W, 0603	0603
55	RLV2	1	49.9k	RC0603FR-0749K9L	Yageo America	RES, 49.9 k, 1%, 0.1 W, 0603	0603
56	SH-J7, SH-J8, SH-J9, SH-J10, SH-J11, SH-J13, SH-J15, SH-J17, SH-J20, SH-J22	10	1x2	959102-0000-0A	3M	Shunt, 100mI, Gold plated, Black	Shunt
57	TP1, TP2, TP3, TP4, TP5, TP6, TP7, TP8, TP9, TP10, TP11, TP12, TP13, TP14, TP15, TP16	16	Red	5000	Keystone	Test Point, Miniature, Red, TH	Red Miniature Testpoint
58	TPG1, TPG2, TPG3, TPG4, TPG5, TPG6, TPG7, TPG8	8	Black	5001	Keystone	Test Point, Miniature, Black, TH	Black Miniature Testpoint
59	U1, U2	2		TPS26090QRGTR01	Texas Instruments	3-A High-Efficient Synchronous Step-Down Converter with DCS-Control, RCT0016C	RG10016C
60	U3	1		LM25117QPMH/NOPB	Texas Instruments	Wide Input Range Synchronous Buck Controller with Analog Current Monitor, PWP0020A	PWP0020A
61	U4, U6	2		TPS22965TDSGRQ1	Texas Instruments	5.5-V, 4-A, 16-mOhm On-Resistance Load Switch, DSG0008A	DSG0008A
62	U5, U7	2		TPS22965TDSGRQ1	Texas Instruments	5.5-V, 4-A, 16-mOhm On-Resistance Load Switch, DSG0008A	DSG0008A
63	U8, U9	2		LMC555CM	Texas Instruments	CMOS Timer, 8-pin, Narrow SOIC	N808
64	J10	1		TPS7A6550QKURQ1	Texas Instruments	Single Output Automotive LDO, 300 mA, Fixed 5 V Output, 4 to 40 V Input, 3-pin PFM (KVU), -40 to 125 degC, Green (RoHS & no Sb/Br)	KVU0003A
65	U11, U12, U13, U14, U15, U16	6		TPS22915BYFP	Texas Instruments	Single Channel Ultra-Low Resistance Load Switch, YFP0004AAA	YFP0004AAA
66	CL1A, CL2A, CL3A, CL4A	0	10uF	GRM21BR6YA106KE43L	MuRata	CAP, CERM, 10 uF, 35 V, +/- 10%, XSR, 0805	0805
67	CSNB	0	10uF	C2012X7R1A106M125AC	TDK	CAP, CERM, 10 uF, 10 V, +/- 20%, XTR, 0805	0805
68	CT1, CT2, CT3, CT4	0	1000pF	O402C102J3RACTU	Kemet	CAP, CERM, 1000 pF, 25 V, +/- 5%, XTR, 0402	0402
69	FID1, FID2, FID3	0		N/A	N/A	Fiducial mark. There is nothing to buy or mount.	Fiducial
70	RL1_1, RL1_2, RL1_3, RL1_4, RL2_1, RL2_2, RL2_3, RL2_4	0	3.30	CRCW25123R30FKEG	Vishay-Dale	RES, 3.30, 1%, 1 W, 2512	2512
71	RL3_1, RL3_2, RL3_3, RL3_4, RL4_1, RL4_2, RL4_3, RL4_4	0	1.80	CRCW25121R80FKEG	Vishay-Dale	RES, 1.80, 1%, 1 W, 2512	2512
72	RSNB	0	10	RC0805JR-0710RL	Yageo America	RES, 10, 5%, 0.125 W, 0805	0805

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